

1. Description

The TLP250 is a gate driven optocoupler with an output current of 1.5A, with an AlGaAs LED, which is coupled to a photosensitive integrated circuit through infrared light. This optocoupler can drive most low-power IGBTs and MOSFETs. In the motor control inverter and high-performance power system applications, it is very suitable for fast switching drive power IGBTs and MOSFETs.

3. Features

- 35kV/ μ s minimum Common Mode Rejection
- 1.5A maximum peak output current
- Wide operating V_{CC} Range: 10V~35V
- 400ns maximum propagation delay

2. Applications

- Uninterrupted Power Supply
- IGBT isolation / power MOSFET gate drive
- Induction heating
- Industrial inverters

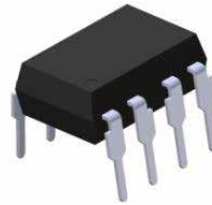
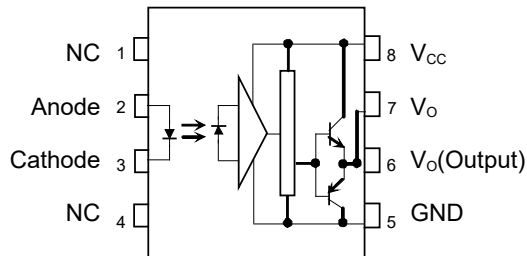
- 100ns of pulse width distortion
- Under Voltage Lock-Out protection (UVLO) with hysteresis
- Operating temperature range: -20°C~ +85°C

4. Truth Table

Input	LED	M1	M2	Output
H	ON	ON	OFF	H
L	OFF	OFF	ON	L



5. Pinning Information

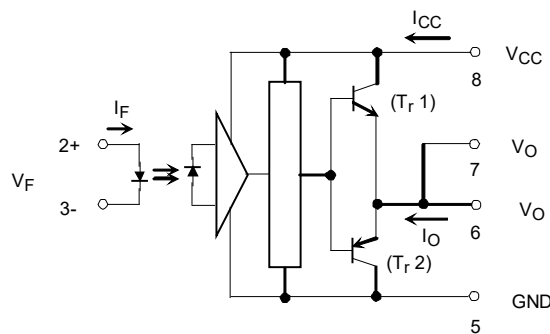


DIP-8



SOP- 8

6. Schematic



A 0.1 μ F bypass capacitor must be connected between pin 8 and 5

7. Insulation And Safety Related Specifications

Parameter	Symbol	Note	Value	Unit
Creepage Distance	L	Measured from input terminals to output terminals, shortest distance path along body	≥ 7	mm
Clearance Distance	L	Measured from input terminals to output terminals, shortest distance through air	≥ 7	mm
Insulation Thickness	DTI	Insulation thickness between emitter and detector	≥ 0.4	mm
Peak Isolation Voltage	V_{IORM}	DIN/EN/IEC EN60747-5-5.	1500	V_{peak}
Transient Isolation Voltage	V_{IOTM}	DIN/EN/IEC EN60747-5-5.	7000	V_{peak}
Isolation Voltage	V_{ISO}	For 1 min	5000	V_{rms}



8. Absolute Maximum Ratings $T_A = 25^\circ\text{C}$

Parameter		Symbol	Value	Units
Input	Forward Input Current	I_{FM}	25	mA
	Reverse Voltage	V_R	5	V
Output	Peak Output Current ⁽¹⁾	$I_{O(PEAK)}$	1.5	A
	Supply Voltage	V_{CC}	35	V
	Output Voltage	V_O	35	V
Isolation Voltage		V_{ISO}	5000	V_{rms}
Total Power Consumption		P_{tot}	200	mW
Operating Temperature		T_{opr}	-20 to 85	$^\circ\text{C}$
Storage Temperature		T_{stg}	-55 to 125	$^\circ\text{C}$
Soldering Temperature ⁽²⁾		T_{sol}	260	$^\circ\text{C}$

Note:

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

1. Exponential waveform.

2. ≥ 2 mm below seating plane.



9. Recommended Operating Conditions

Parameter	Symbol	Min	Max	Units
Power Supply Voltage ⁽¹⁾	V_{CC}	15	30	V
Input Current (ON) ⁽²⁾	$I_{F(ON)}$	7	10	mA
Input Voltage (OFF)	$V_{F(OFF)}$	0	0.8	V
Operating Temperature	T_A	-20	85	°C

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this datasheet should also be considered.

Note: A ceramic capacitor (0.1μF) should be connected between pin 8 and pin 5 to stabilize the operation of a highgain linear amplifier. Otherwise, this photocoupler may not switch properly. The bypass capacitor should be placed within 1 cm of each pin.

Note : If the rising slope of the supply voltage (V_{CC}) for the detector is steep, stable operation of the internal circuits cannot be guaranteed. Be sure to set 3.0 V/μs or less for a rising slope of the V_{CC} .

Note 1: Denotes the operating range, not the recommended operating condition.

Note 2: The rise and fall times of the input on-current should be less than 0.5μs.



10. Electro-optical Characteristics (T_A=25°C)

All minimum and maximum specifications are at recommended operating conditions, unless otherwise noted

All typical values are at T_A=25°C, V_{DD}=30V, and V_{SS}=GND.

Parameter			Symbol	Conditions		Min	Typ	Max	Units
Input forward voltage			V _F	I _F =10mA, T _A =25°C			1.6	1.8	V
Temperature coefficient of forward voltage			ΔV _F /ΔT _A	I _F =10mA			-2		mV/°C
Input reverse current			I _R	V _R =5V, T _A =25°C				10	μA
Input capacitance			C _t	V=0V, f=1MHz, T _A =25°C			45	250	pF
Output current ⁽¹⁾	Test 1	“H” level	I _{OPH}	V _{CC} =30V	I _F =10mA, V ₈₋₆ =4V	-0.5	-1.5		A
	Test 2	“L” level	I _{OPL}		I _F =0mA, V ₆₋₅ =2.5V	0.5	2		A
Output voltage	Test 3	“H” level	V _{OH}	V _{CC1} =15V, V _{EE1} =-15V, R _L =200Ω, I _F =5mA		11	12.8		V
	Test 4	“L” level	V _{OL}	V _{CC1} =15V,V _{EE1} =-15V,R _L =200Ω,I _F =0.8mA			-14.2	-12.5	V
Supply current		“H” level	I _{CCH}	V _{CC} =30V, I _F =10mA, T _A =25°C			7		mA
				V _{CC} =30V, I _F =10mA				11	mA
		“L” level	I _{CCL}	V _{CC} =30V, I _F =0mA, T _A =25°C			7.5		mA
				V _{CC} =30V, I _F =0mA				11	mA
Threshold input current		“Output L→H”	I _{FLH}	V _{CC1} =15V, V _{EE1} =-15V R _L =200Ω, V _O >0V			1.2	5	mA
Threshold input voltage		“Output H→L”	V _{FHL}	V _{CC1} =15V, V _{EE1} =-15V R _L =200Ω, V _O <0V		0.8			V
Supply voltage			V _{CC}			10		35	V
Capacitance (input-output) ⁽¹⁾			C _S	V _S =0V, f=1MHz, T _A =25°C			1	2	pF
Resistance (input-output) ⁽¹⁾			R _S	V _S =500V, T _A =25°C, R.H.≤ 60 %		1×10 ¹²	10 ¹⁴		Ω
Isolation Resistance			R _{ISO}	V _{I-O} =500V, 40~60%R.H.			10 ¹¹		Ω
Isolation Capacitance			C _{ISO}	V _{I-O} =0V, Freq=1MHZ			1		pF



Parameter	Symbol	Conditions	Min	Typ	Max	Units
Propagation Delay Time to Low Output Level ⁽¹⁾	T_{PHL}	$I_F=7mA$ to $16mA$, $R_g=10\Omega$, $C_g=10NF$ $F=10KHZ$, Duty Cycle=50%		100	300	ns
Propagation Delay Time to High Output Level ⁽¹⁾	T_{PLH}			100	300	ns
Pulse Width Distortion	PWD			3	100	ns
Propagation Delay Difference Between Any Two Parts	PDD		-250		250	ns
Output Rise Time(10% To 90%) ⁽¹⁾	T_R	$I_F=7mA$ to $16mA$, $R_g=10\Omega$, $C_g=10NF$ $F=10KHZ$, Duty Cycle=50%		80		ns
Output Drop Time(90%~10%) ⁽¹⁾	T_F			80		ns
Output High Level Common Mode Transient Immunity ⁽²⁾	$ CM_H $	$T_A=25^\circ C$, $V_{DD}=30V$ $V_{CM}=2000V$, $I_F=7\sim 16mA$, $V_F=0V$	35	50		KV/ μs
Output Low Level Common Mode Transient Immunity ⁽³⁾	$ CM_L $	$T_A=25^\circ C$, $V_{DD}=30V$ $V_{CM}=2000V$, $I_F=7\sim 16mA$, $V_F=0V$	35	50		KV/ μs

Note: All typical values are at $T_a=25^\circ C$.

Note 1: Input signal ($f = 250$ kHz, duty = 50 %, $t_r = t_f = 5$ ns or less).

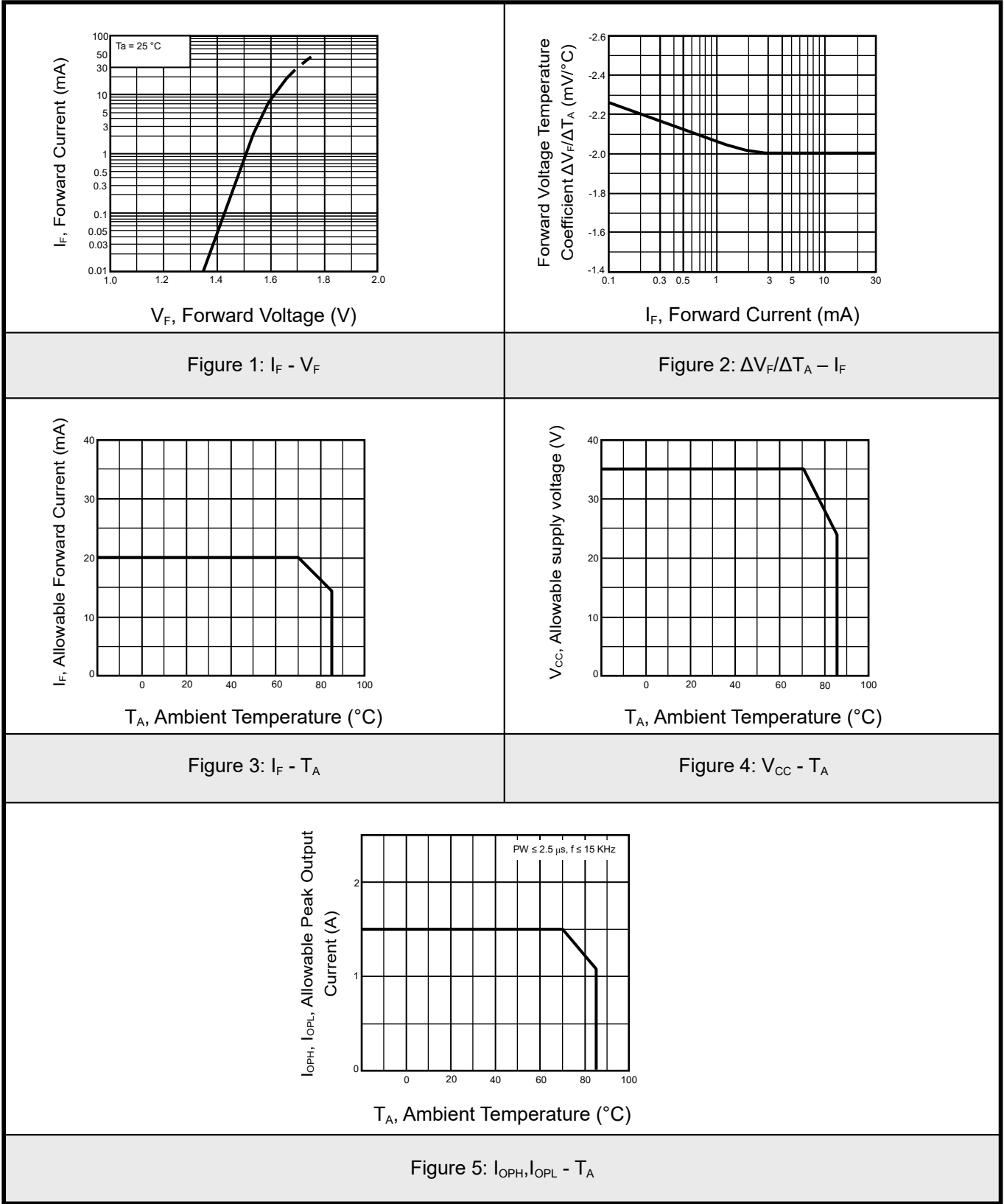
C_L is approximately 15 pF which includes probe and stray wiring capacitance.

Note 2: CM_H is the maximum rate of rise of the common mode voltage that can be sustained with the output voltage in the logic high state ($V_O > 26$ V).

Note 3: CM_L is the maximum rate of fall of the common mode voltage that can be sustained with the output voltage in the logic low state ($V_O < 1$ V).

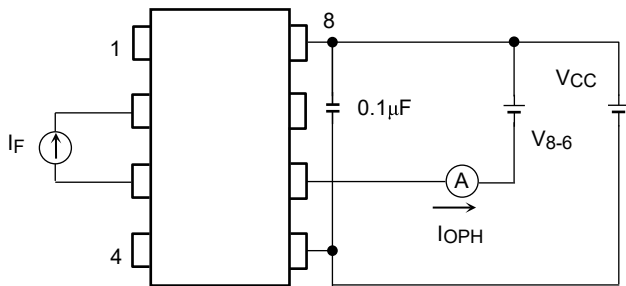
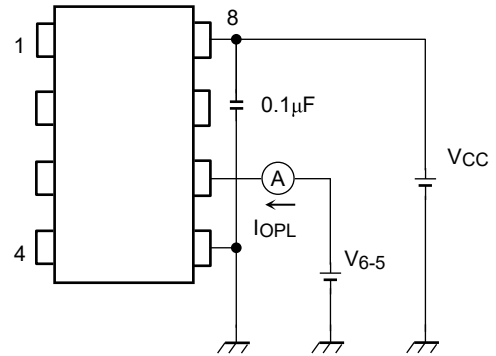
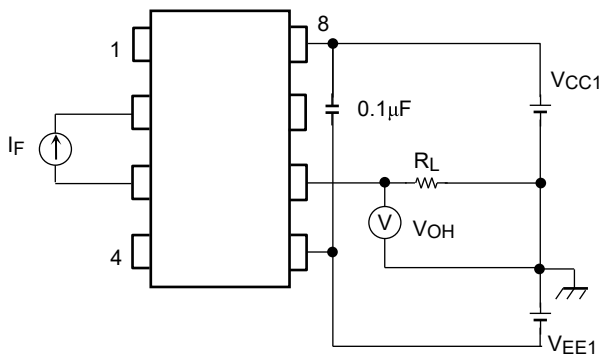
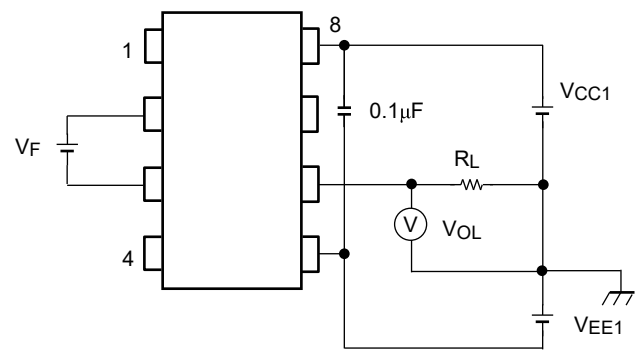


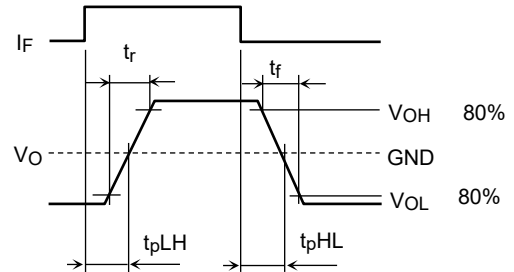
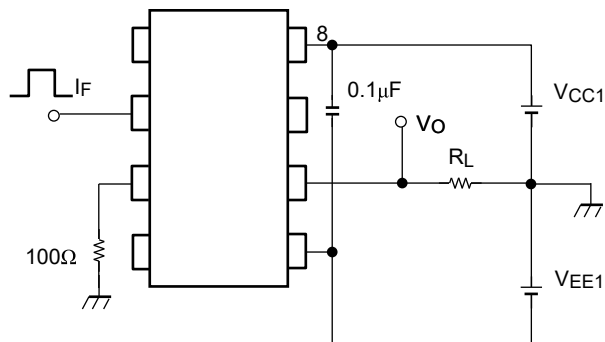
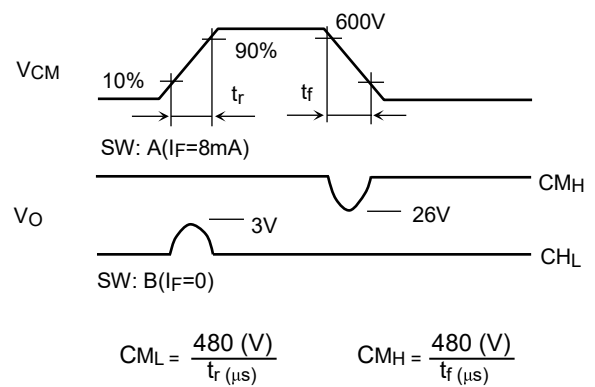
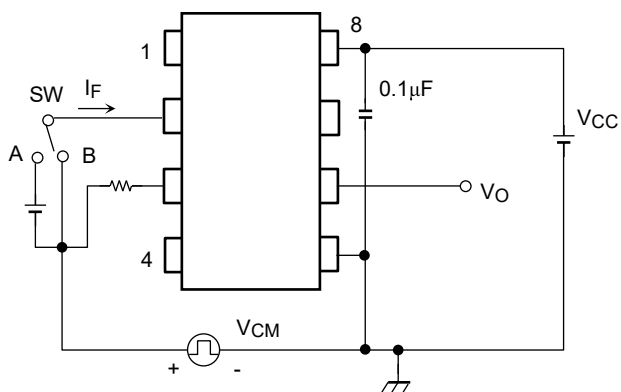
11. Typical Characteristic





12. Typical Electro-Optical Characteristics Curves

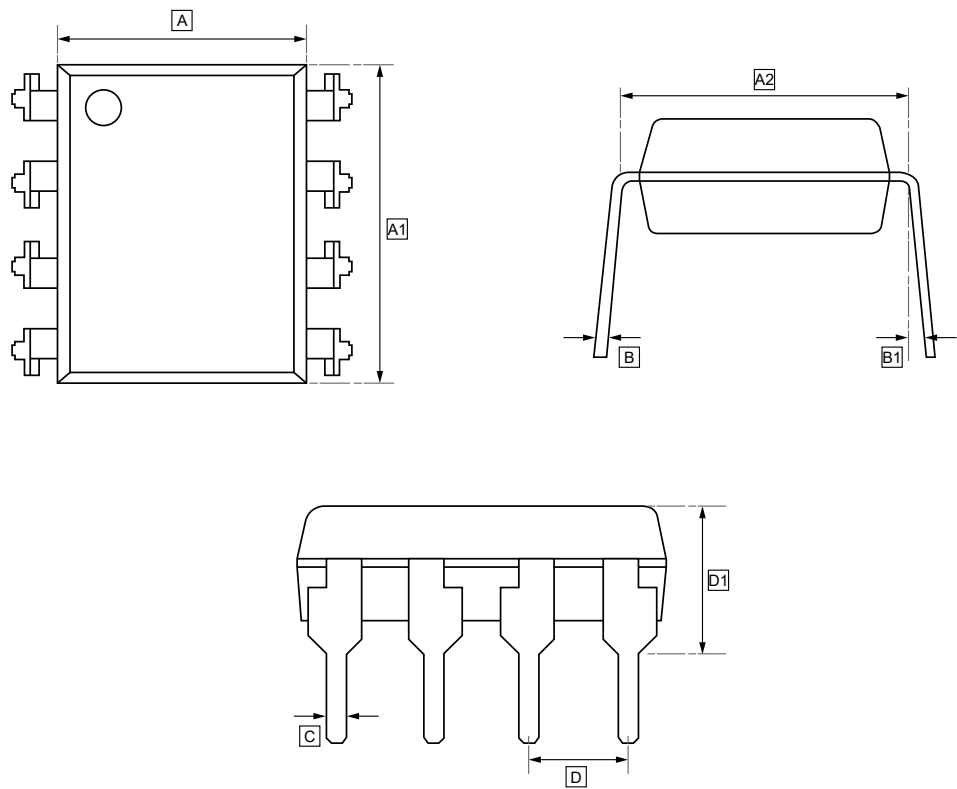
Test Circuit 1 : I_{OPH} Test Circuit 2 : I_{OPL} Test Circuit 3 : V_{OH} Test Circuit 4 : V_{OL}

Test Circuit 5: t_{pLH} , t_{pHL} , t_r , t_f Test Circuit 6: CM_H , CM_L

CM_L (CM_H) is the maximum rate of rise (fall) of the common mode voltage that can be sustained with the output voltage in the low (high) state.



13.1 DIP-8 Package Outline Dimensions

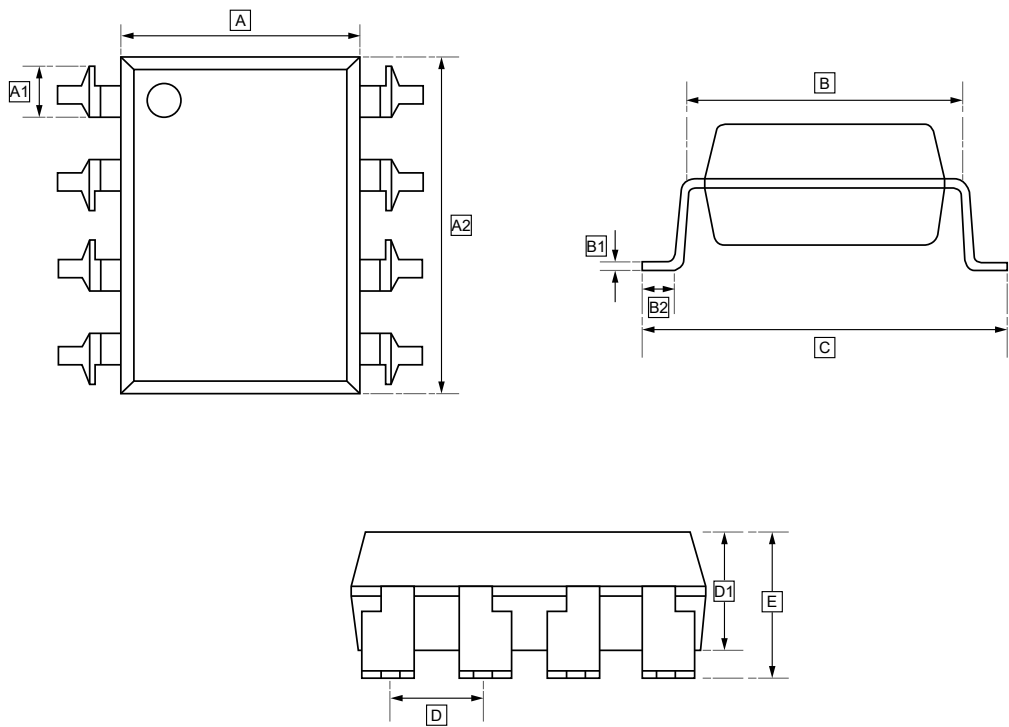


DIMENSIONS (mm are the original dimensions)

Symbol	A	A1	A2	B	B1	C	D	D1
Min	6.30	9.46	7.62	0.25	5°	0.40	2.54	4.20
Max	6.90	10.06	TYP.		15°	0.60	TYP.	4.80



13.2 SOP-8 Package Outline Dimensions

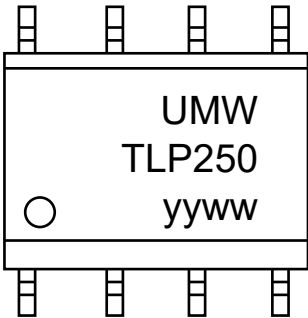


DIMENSIONS (mm are the original dimensions)

Symbol	A	A1	A2	B	B1	B2	C	D	D1	E
Min	6.30	1.45	9.46	7.62	0.25	0.6	-	2.54	3.20	4.00
Max	6.90		10.06	TYP		-	10.3	TYP	3.80	4.60



14.Ordering Information



yy: Year Code
ww: Week Code

Order Code	Marking	Package	Base QTY	Delivery Mode
UMW TLP250	TLP250	SOP-8	1000	Tape and reel
UMW TLP250F	TLP250F	DIP-8	2250	Tube and box



15.Disclaimer

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